

RF Probing Solutions

- Manual, Semiautomatic & Fully Automatic Versions
 - Single-Sided or Double-Sided
 - Vacuum (semi and fully automatic)
- Amplifiers, MMICS, T/R Modules, Hybrids, MEMS, Silicon Photonics (die, partial die, wafers, frames)
- Thermal Systems from -60 C to 300 C
- Thin Wafer Material Handling
- Customized Chucks and Carrier Plates
- Manipulators – manual, programmable and hexapods
- Non-Contact Height Measurement Sensors
- Probe Tips, Probe Cards, Wedges
- Integrated Solutions – Tuners, VNAs, Extension Modules
- Modular PS4L Hardware & Software Architecture

